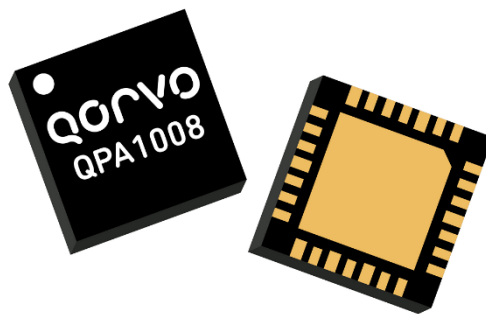


Product Description

Qorvo's QPA1008 is an S-band two stage variable gain driver amplifier in a 5x5 mm QFN. The QPA1008 operates from 2.7 to 3.8 GHz and provides 31dBm of P1dB output power with 26 dB of large signal gain and greater than 30% PAE. The QPA1008 includes a 30 dB attenuator at the input, and a simple resistively coupled (~20 dB coupling) power sampler detector at the output. The amplifier has a fast bias control switch for quick turn on and off operation.



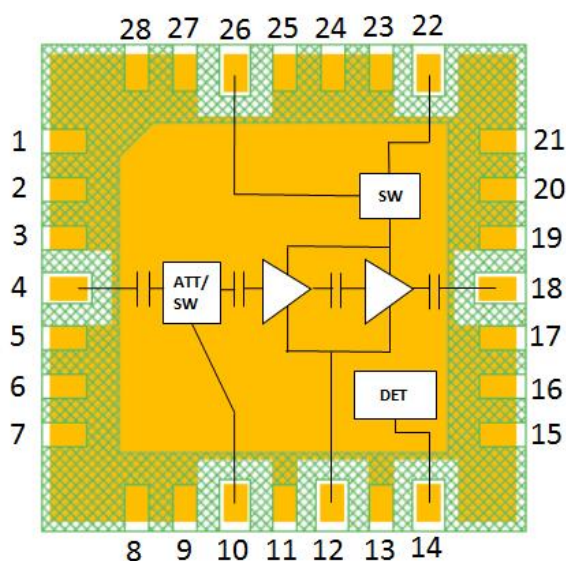
5mm x 5mm 28 Lead OVM QFN

Product Features

- Frequency Range: 2.7 – 3.8 GHz
- Small Signal Gain: 28 dB
- Input Return Loss: 16 dB
- Output Return Loss: 15 dB
- 32dB Attenuation Range
- P1dB: 31dBm
- Large Signal Gain: 26 dB
- P1dB PAE: 35 %
- Bias Switching Speed: 20 nS
- Bias: $V_{CC} = 6\text{ V}$, $I_{CQ} = 400\text{ mA}$
- Package Dimensions: 5.0 x 5.0 x 0.82 mm

Performance is typical across frequency. Please reference electrical specification table and data plots for more details.

Functional Block Diagram



Applications

- Commercial & Military Radar
- Communications
- Test Instrumentation

Ordering Information

Part	Description
QPA1008SR	2.7 – 3.8 GHz Driver Amplifier 100 Piece 7" Reel
QPA1008TR7	750 Piece 7" Reel
QPA1008EVB01	Evaluation Board

Absolute Maximum Ratings

Parameter	Value / Range
Collector Voltage (V_{CC})	3.3 V - 7 V
Collector Current (I_{CC})	1.2 A
Dissipated Power (P_{DISS}), $T_{BASE} = 85^{\circ}\text{C}$, $T_{CH} = 175^{\circ}\text{C}$, CW	3.2 W
Input Power (50 Ω , 85°C)	29 dBm
Channel Temperature, T_{CH}	175 $^{\circ}\text{C}$
Mounting Temperature (30 seconds)	260 $^{\circ}\text{C}$
Storage Temperature	-55 to 150 $^{\circ}\text{C}$

Operation of this device outside the parameter ranges given above may cause permanent damage. These are stress ratings only, and functional operation of the device at these conditions is not implied.

Recommended Operating Conditions

Parameter	Value
Collector Voltage (V_{CC})	6 V
Collector Current (quiescent, I_{CQ})	400 mA
Collector Current (under drive, I_{CD})	1 A
V_{PD}	5 V
V_{SW}	5 V
T_J Max	165 $^{\circ}\text{C}$
Operating Temperature Range	-40 to 85 $^{\circ}\text{C}$

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

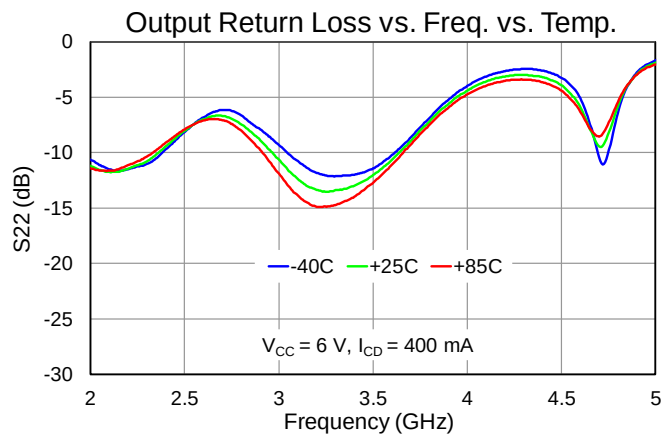
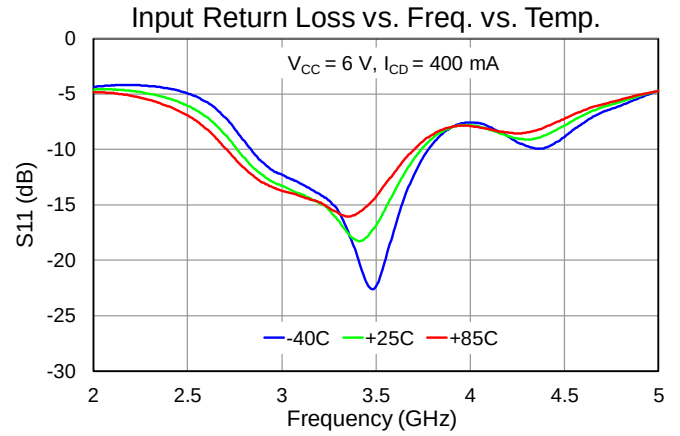
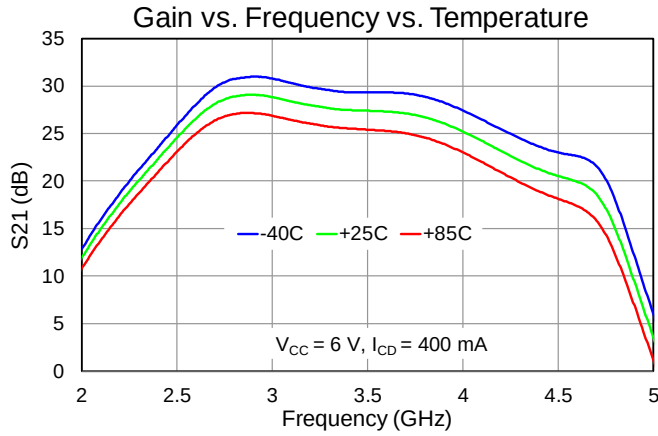
Electrical Specifications

Test conditions, unless otherwise noted: 25 $^{\circ}\text{C}$, $V_{CC} = 6$ V, $I_{CQ} = 400$ mA, $V_{PD} = 5$ V, $V_{SW} = 5$ V, CW

Parameter	Min	Typical	Max	Units
Operating Frequency Range	2.7	3.3	3.8	GHz
Output Power @ 1dB Compression (P_{1dB})		30.8		dBm
Power Added Efficiency @ 1dB Compression (P_{1dB})		34.6		%
Small Signal Gain		28		dB
Input Return Loss		16		dB
Output Return Loss		15		dB
OIP3 ($P_{OUT}/\text{tone} \leq 22$ dBm)		42		dBm
IM3 ($P_{OUT}/\text{tone} \leq 22$ dBm)		-37		dBc
Gain Control Range		32		dB
Switching Speed		20		nS
Attenuator / Switch Control (V_{SW}) Voltage Range	0		5	V
Small Signal Temperature Coefficient		0.031		dB/ $^{\circ}\text{C}$
Output Power Temperature Coefficient		0.004		dB/ $^{\circ}\text{C}$

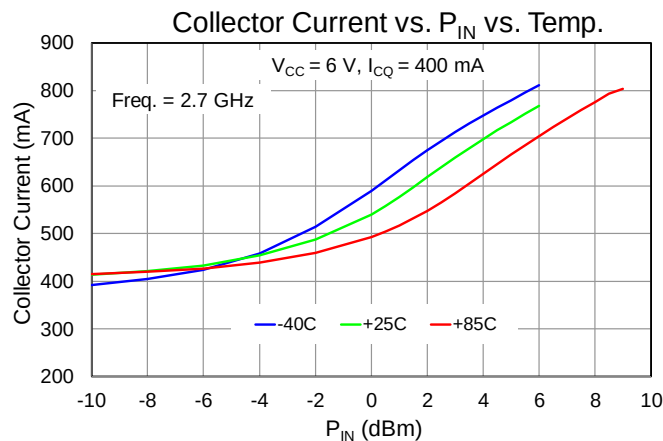
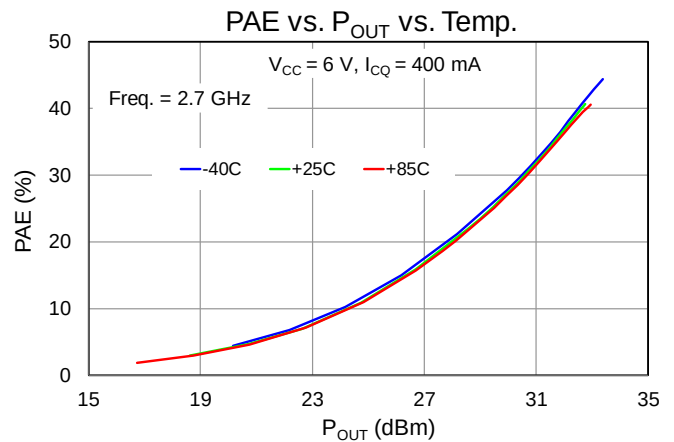
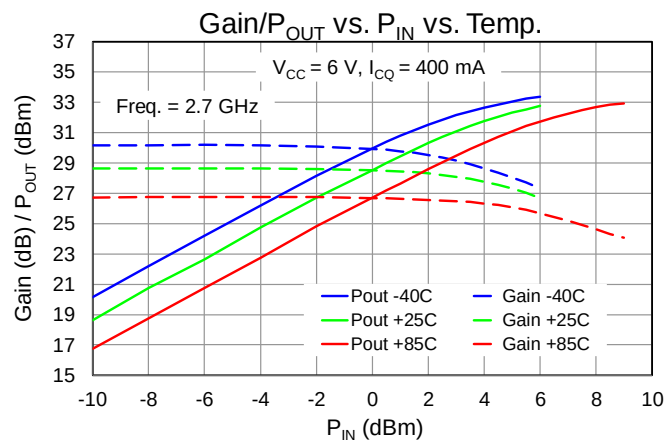
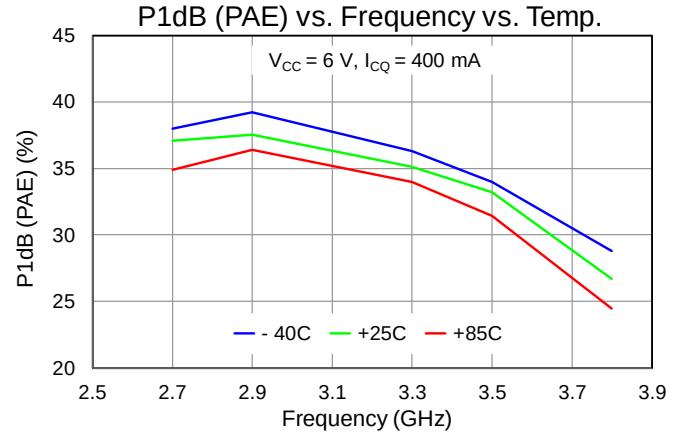
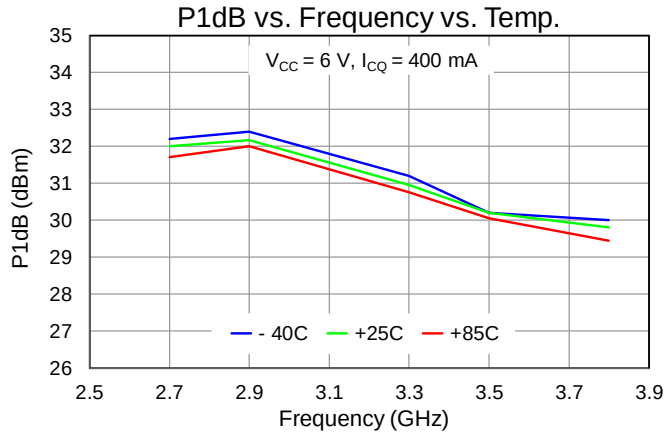
Performance Plots – Small Signal

Test conditions unless otherwise noted: Temp. = 25 °C, $V_{CC} = 6$ V, $I_{CQ} = 400$ mA, $V_{PD} = 5$ V, $V_{SW} = 5$ V, CW



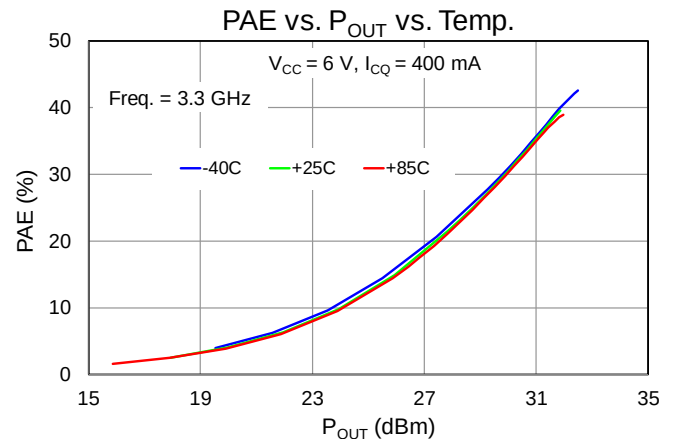
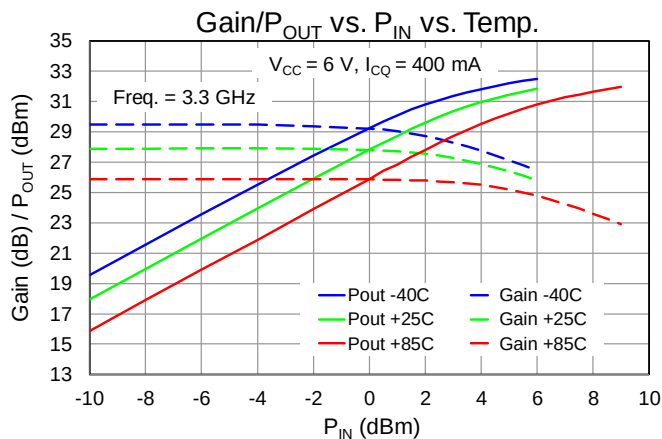
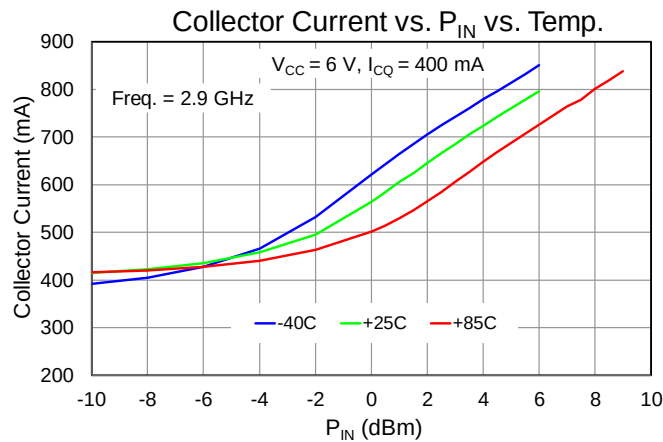
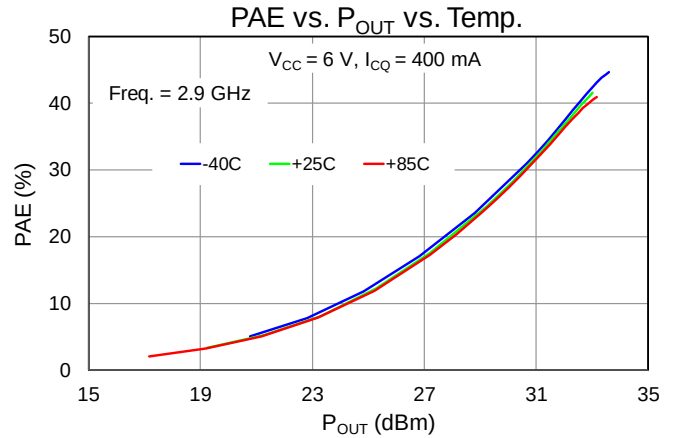
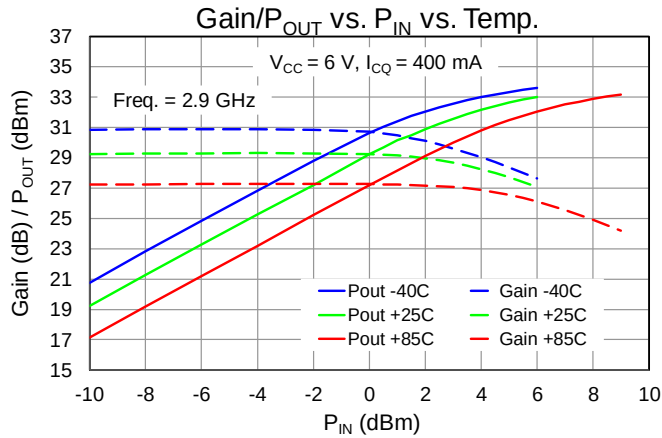
Performance Plots – Large Signal

Test conditions unless otherwise noted: Temp. = 25 °C, $V_{CC} = 6\text{ V}$, $I_{CQ} = 400\text{ mA}$, $V_{PD} = 5\text{ V}$, $V_{SW} = 5\text{ V}$, CW



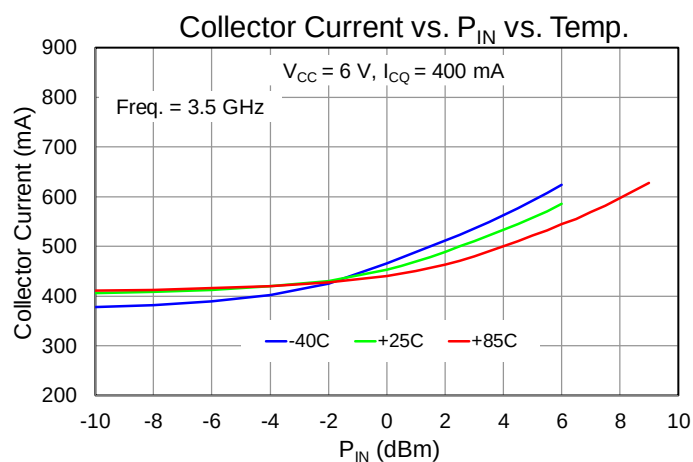
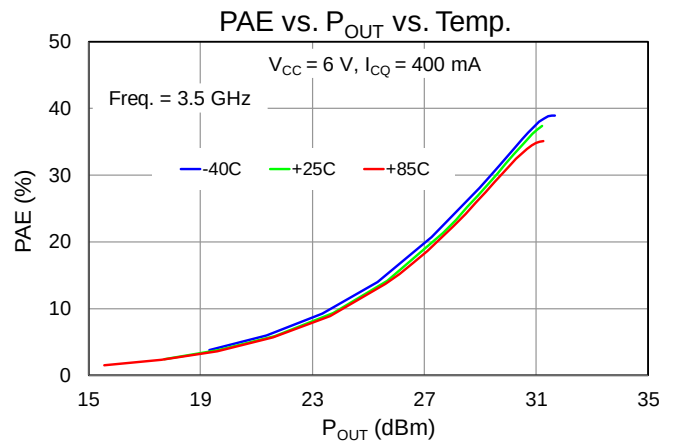
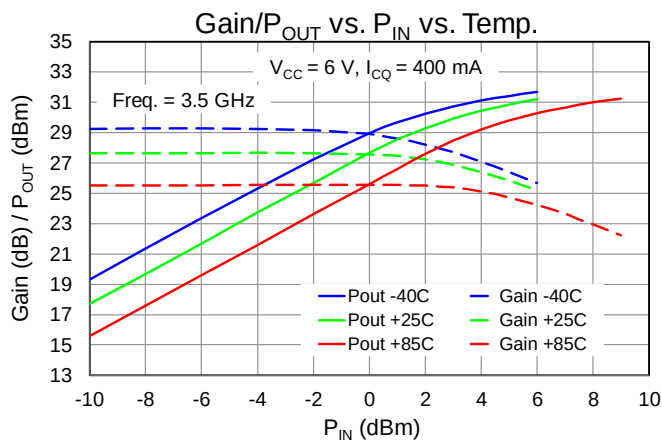
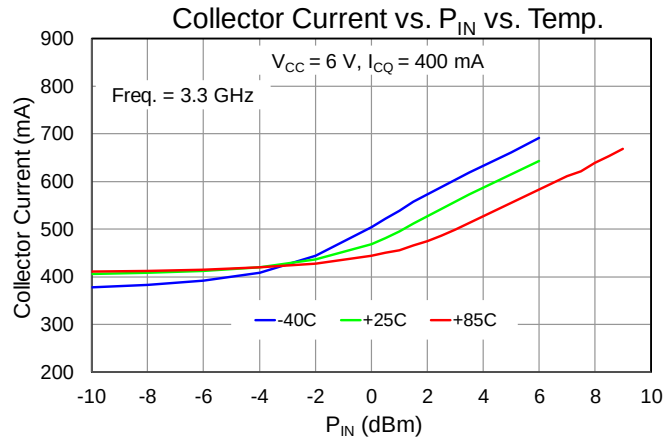
Performance Plots – Large Signal

Test conditions unless otherwise noted: Temp. = 25 °C, $V_{CC} = 6$ V, $I_{CQ} = 400$ mA, $V_{PD} = 5$ V, $V_{SW} = 5$ V, CW



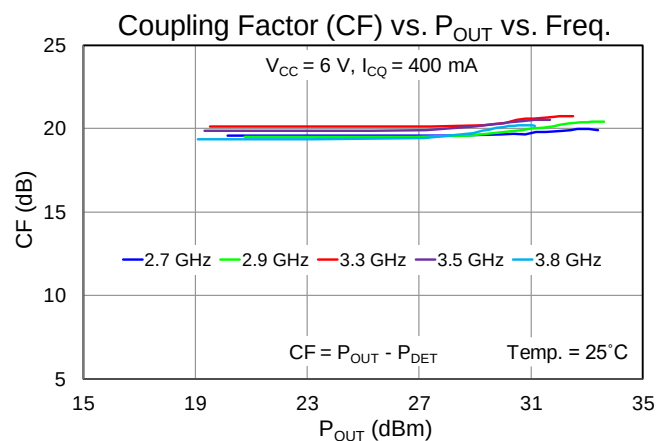
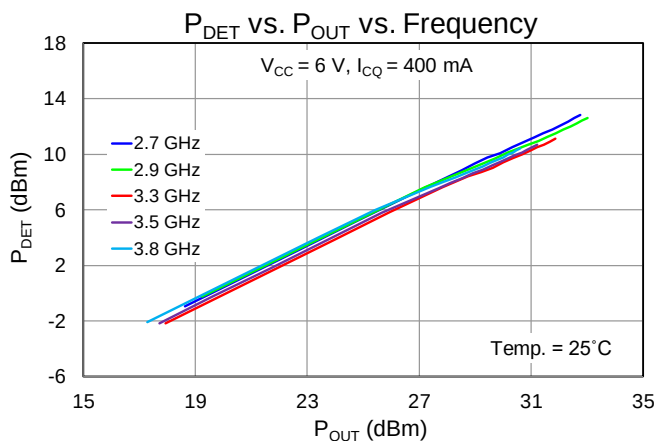
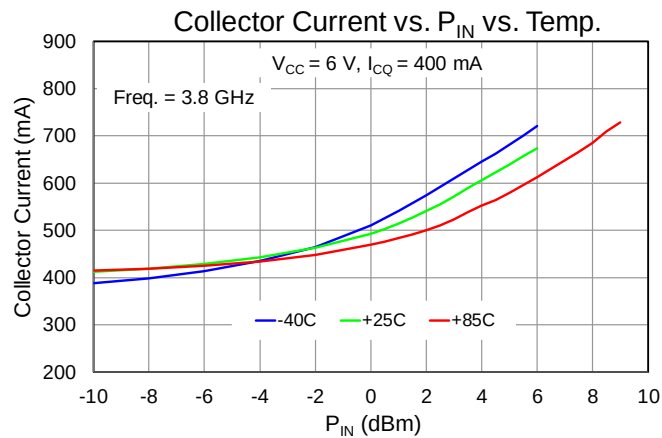
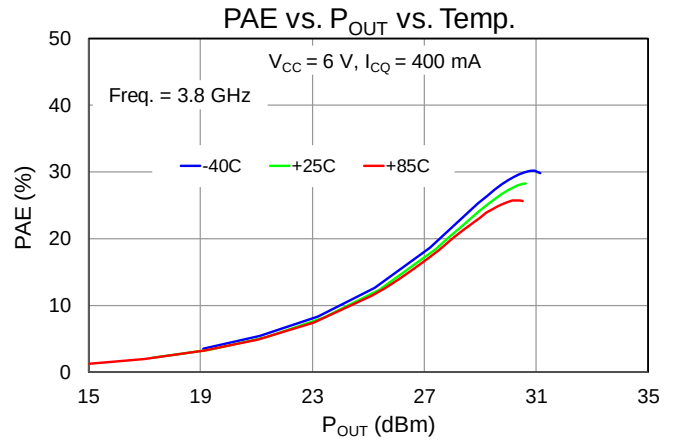
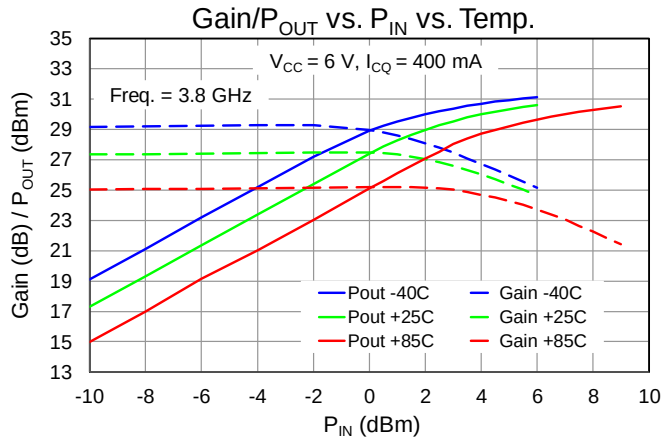
Performance Plots – Large Signal

Test conditions unless otherwise noted: Temp. = 25 °C, $V_{CC} = 6\text{ V}$, $I_{CQ} = 400\text{ mA}$, $V_{PD} = 5\text{ V}$, $V_{SW} = 5\text{ V}$, CW



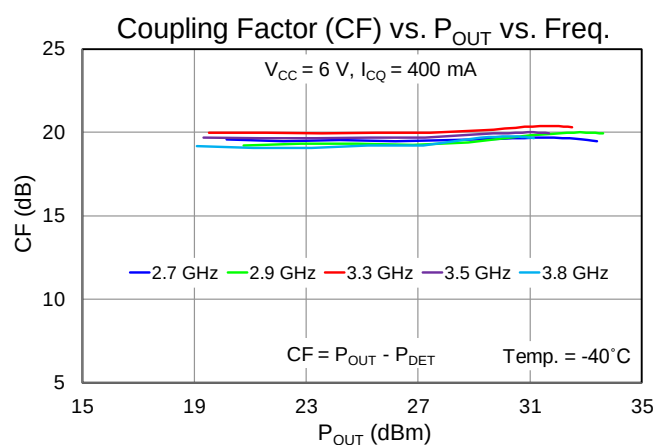
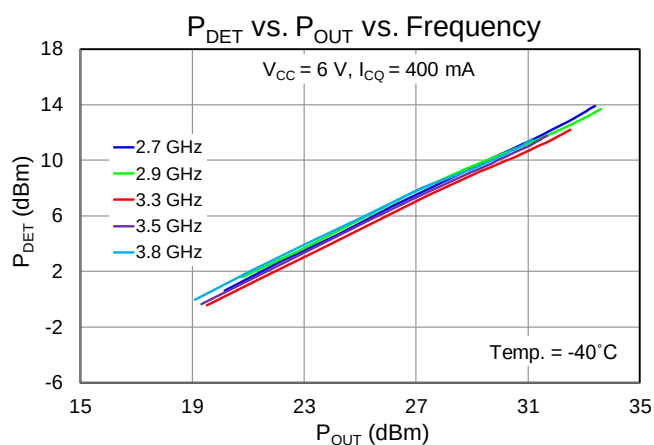
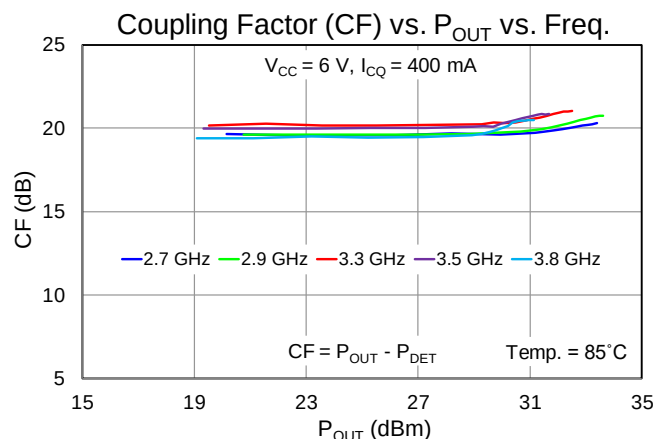
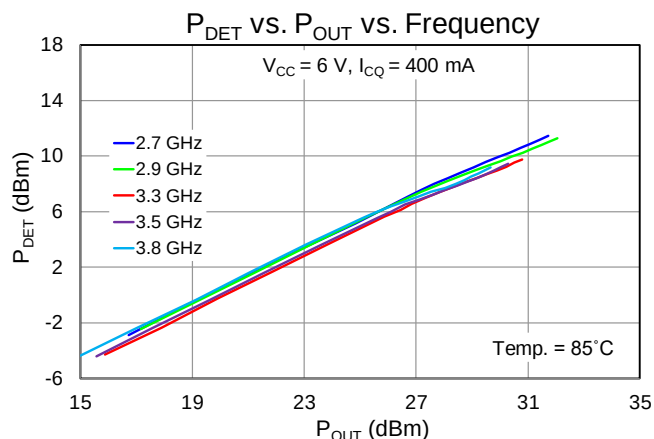
Performance Plots – Large Signal

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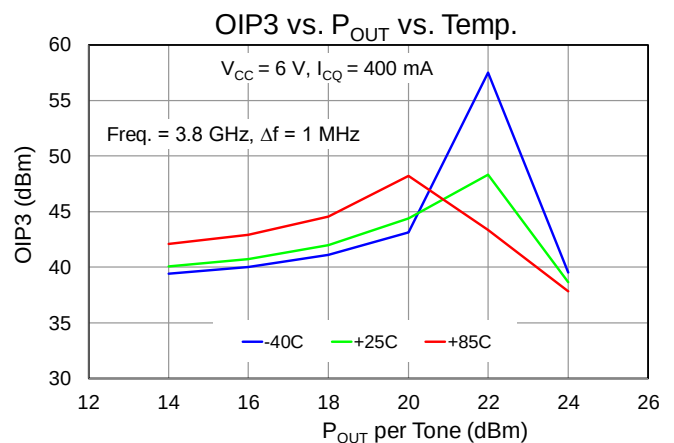
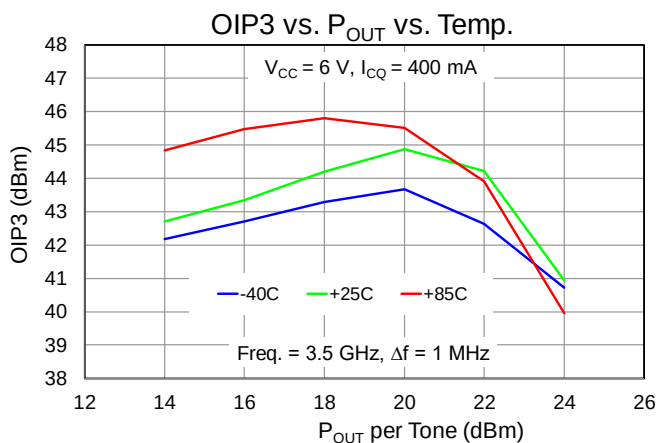
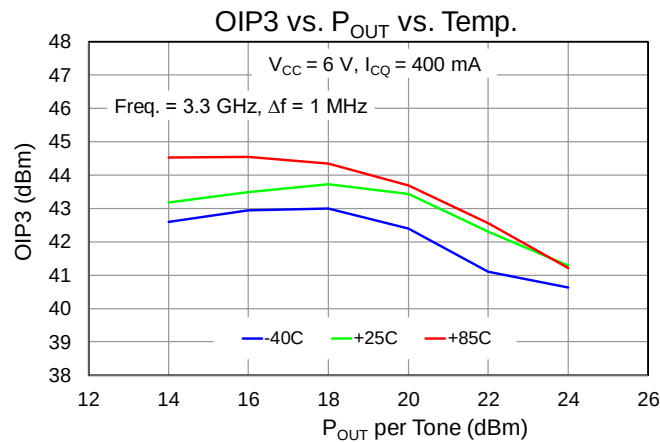
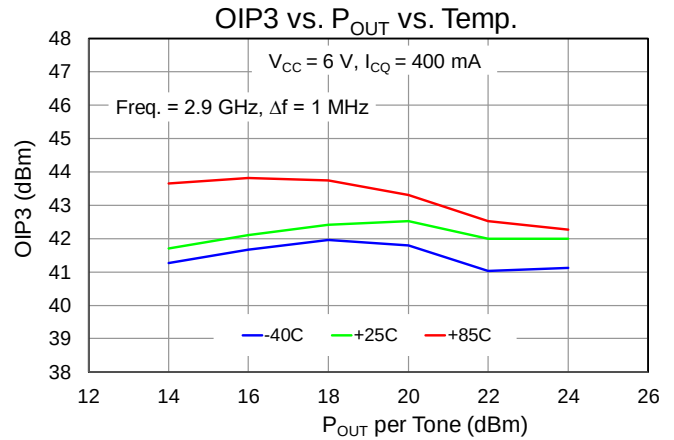
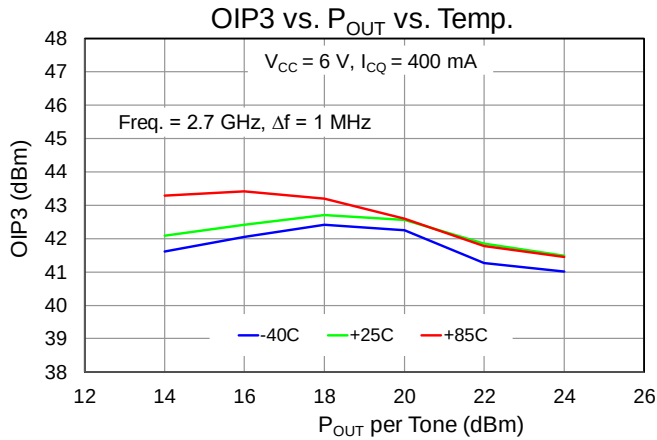
Performance Plots – Large Signal

Test conditions unless otherwise noted: Temp. = 25 °C, $V_{CC} = 6\text{ V}$, $I_{CQ} = 400\text{ mA}$, $V_{PD} = 5\text{ V}$, $V_{SW} = 5\text{ V}$, CW



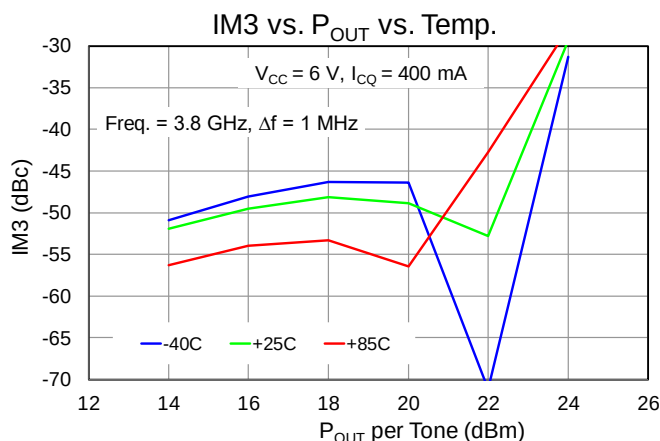
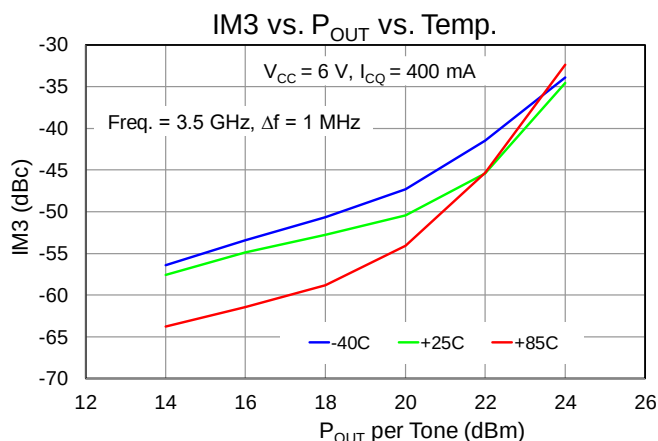
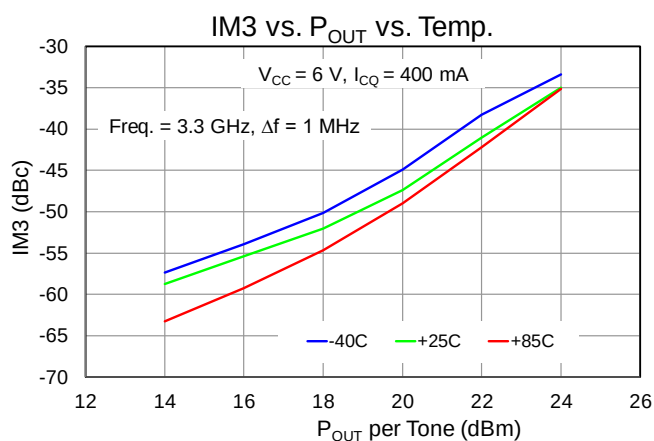
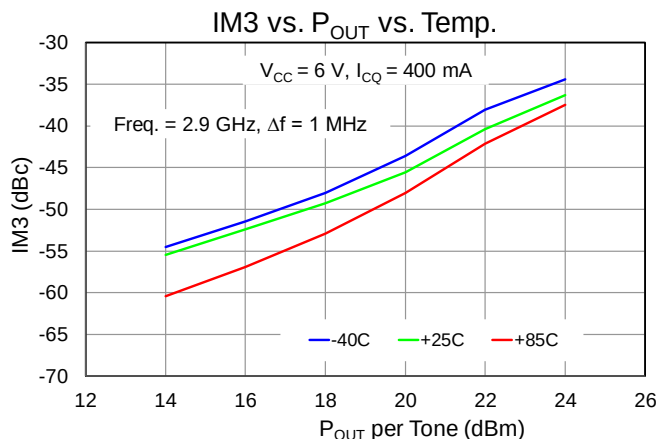
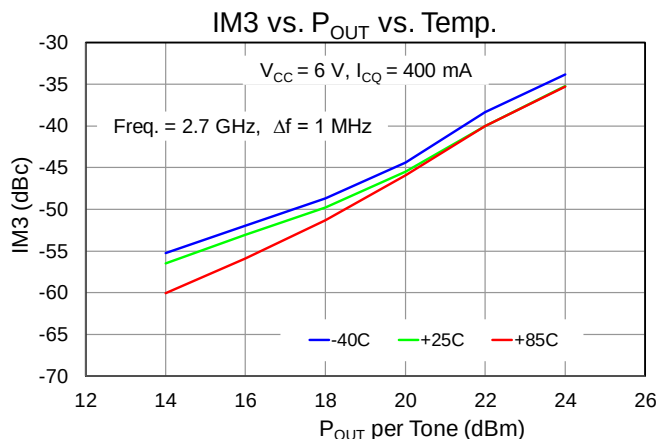
Performance Plots – Linearity

Test conditions unless otherwise noted: Temp. = 25 °C, $V_{CC} = 6$ V, $I_{CQ} = 400$ mA, $V_{PD} = 5$ V, $V_{SW} = 5$ V, CW



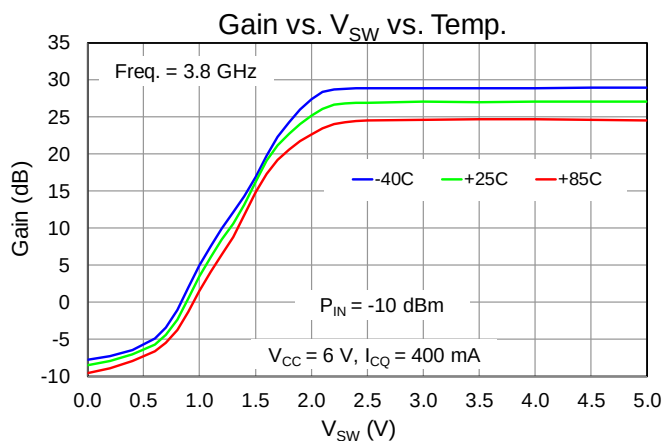
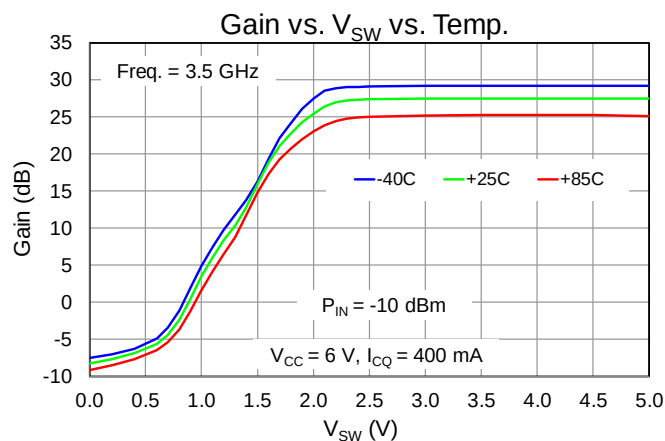
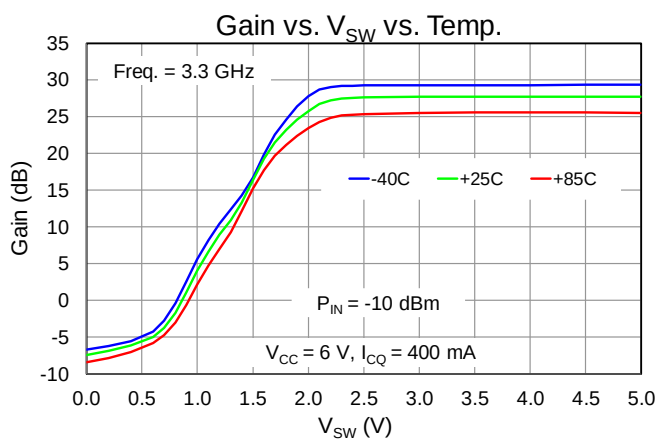
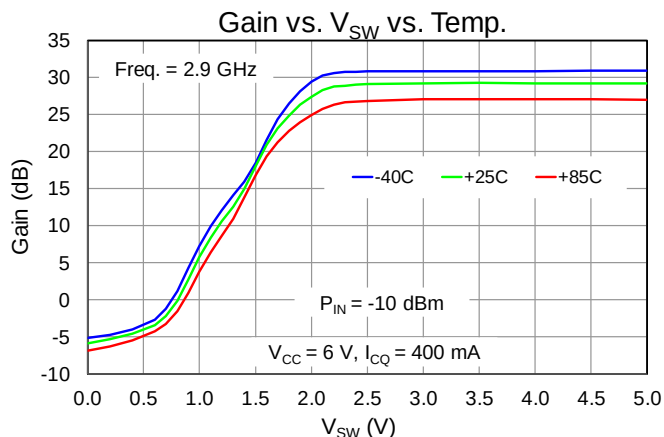
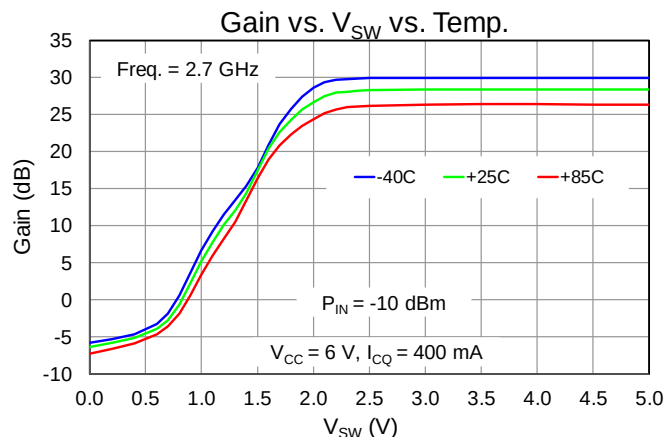
Performance Plots – Linearity

Test conditions unless otherwise noted: Temp. = 25 °C, $V_{CC} = 6\text{ V}$, $I_{CQ} = 400\text{ mA}$, $V_{PD} = 5\text{ V}$, $V_{SW} = 5\text{ V}$, CW



Performance Plots – Attenuation

Test conditions unless otherwise noted: Temp. = 25 °C, $V_{CC} = 6\text{ V}$, $I_{CQ} = 400\text{ mA}$, $V_{PD} = 5\text{ V}$, $V_{SW} = 5\text{ V}$, CW



Thermal and Reliability Information

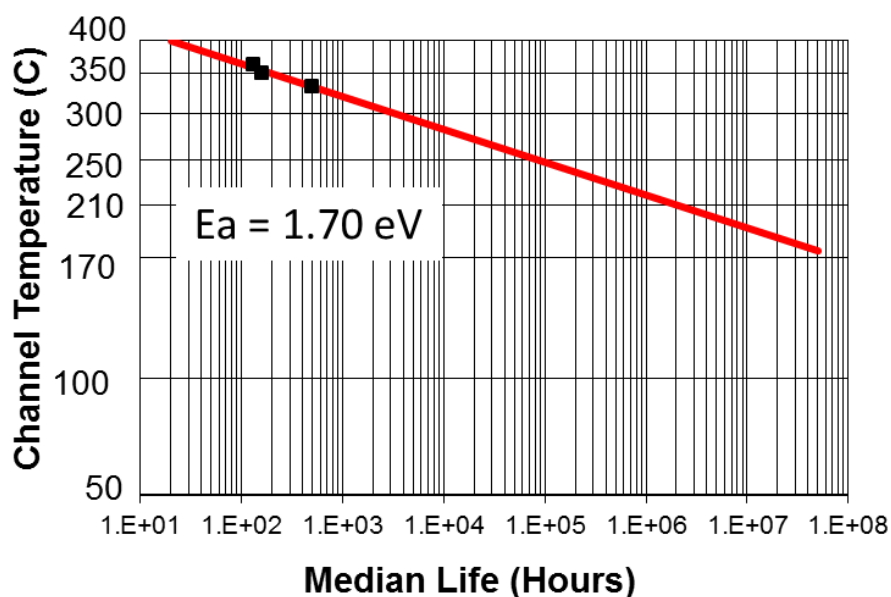
Parameter	Test Conditions	Value	Units
Thermal Resistance (θ_{JC}) ⁽¹⁾	$T_{base} = 85^{\circ}\text{C}$, $T_{case} = 94^{\circ}\text{C}$	29.1	$^{\circ}\text{C/W}$
Channel Temperature (T_{CH}) (Quiescent)	$V_{CC} = 6\text{ V}$, $I_{CQ} = 395\text{ mA}$,	165	$^{\circ}\text{C}$
Median Lifetime (T_M)	$V_{PD} = 5\text{ V}$ $I_{PD} = 13\text{ mA}$ $P_{DISS} = 2.44\text{ W}$	$>8\text{E}+7$	Hrs
Thermal Resistance (θ_{JC}) ⁽¹⁾	$T_{base} = 85^{\circ}\text{C}$, $T_{case} = 97^{\circ}\text{C}$ Freq = 3.8 GHz,	26.1	$^{\circ}\text{C/W}$
Channel Temperature (T_{CH}) (Under RF drive)	$V_{CC} = 6\text{ V}$, $I_{CC} = 589\text{ mA}$,	163	$^{\circ}\text{C}$
Median Lifetime (T_M)	$V_{PD} = 5\text{ V}$ $I_{PD} = 13\text{ mA}$ $P_{IN} = 4\text{ dBm}$, $P_{OUT} = 30.3\text{ dBm}$, $P_{DISS} = 2.53\text{ W}$	$>8\text{E}+7$	Hrs

Notes:

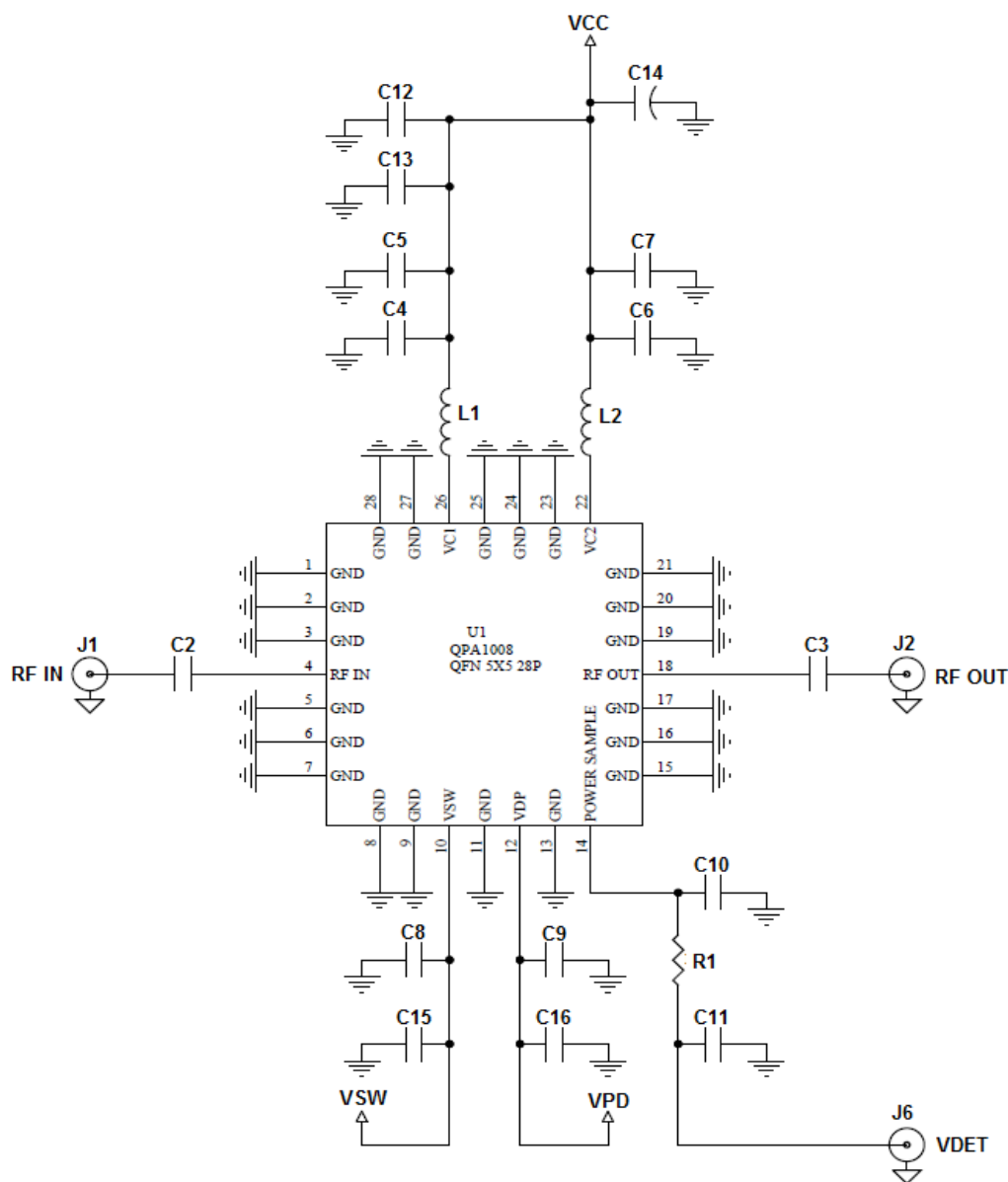
1. Thermal resistance measured to back of EVB.

Median Lifetime

Test Conditions: $V_{CC} = +5\text{ V}$, $J_c = 19.5\text{ kA/cm}^2$ Failure Criteria = 20 % change in Beta for HBT Technology



Applications Circuit



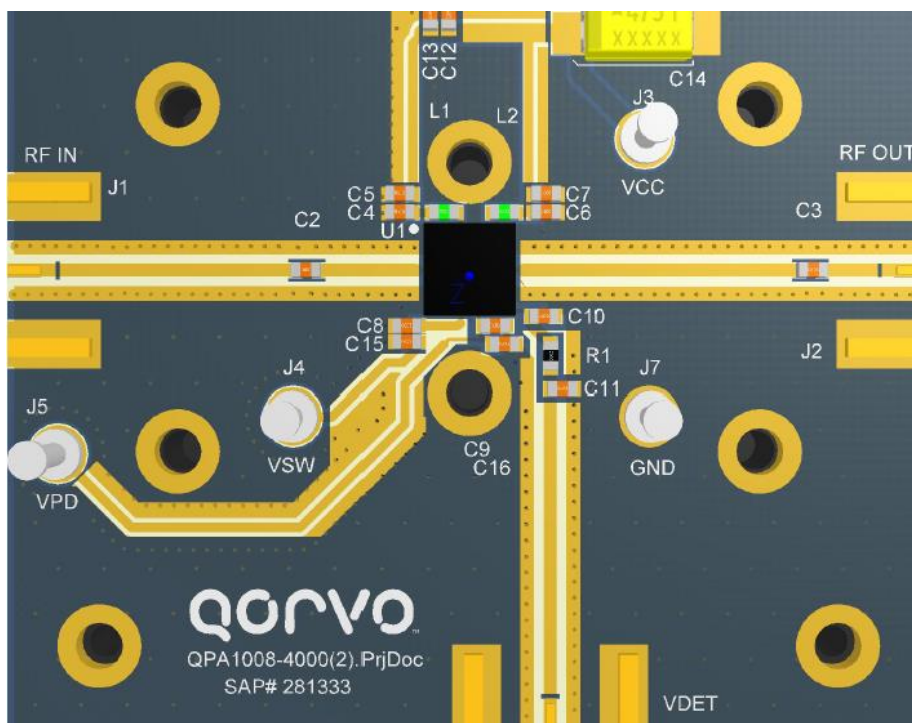
Bias Up Procedure

1. Set Current limits: I_{CC} to 1A, I_{PD} to 20 mA & I_{SW} to 5 mA
2. Set V_{CC} to 6 V; $I_{CQ} \approx 0$ mA
3. Set V_{PD} to 5 V (Switched bias input)
 - $I_{PD} \approx 12$ mA; $I_{CQ} \approx 400$ mA
4. Apply V_{SW} :
 - $V_{SW} = 0$ V (Maximum Attenuation)
 - $V_{SW} = 5$ V (Minimum Attenuation)
5. Apply RF signal

Bias Down Procedure

1. RF off signal
2. Turn Off V_{SW}
3. Turn Off V_{PD}
4. Turn Off V_{CC}

Evaluation Board



↑ 10% +/- 0.062 ↓	0.014	MATL. TYPE N4000-13 Tg 170 DEG C MIN		←	LAYER 1	0.5 OZ BASE COPPER + PLATING
				←	LAYER 2	0.5 OZ BASE COPPER
	0.028	MATL. TYPE FR-4 Tg 170 DEG C MIN		←	LAYER 3	0.5 OZ BASE COPPER
	0.014	MATL. TYPE N4000-13 Tg 170 DEG C MIN		←	LAYER 4	0.5 OZ BASE COPPER + PLATING
				←		

Qorvo PCB Material and Stack-Up

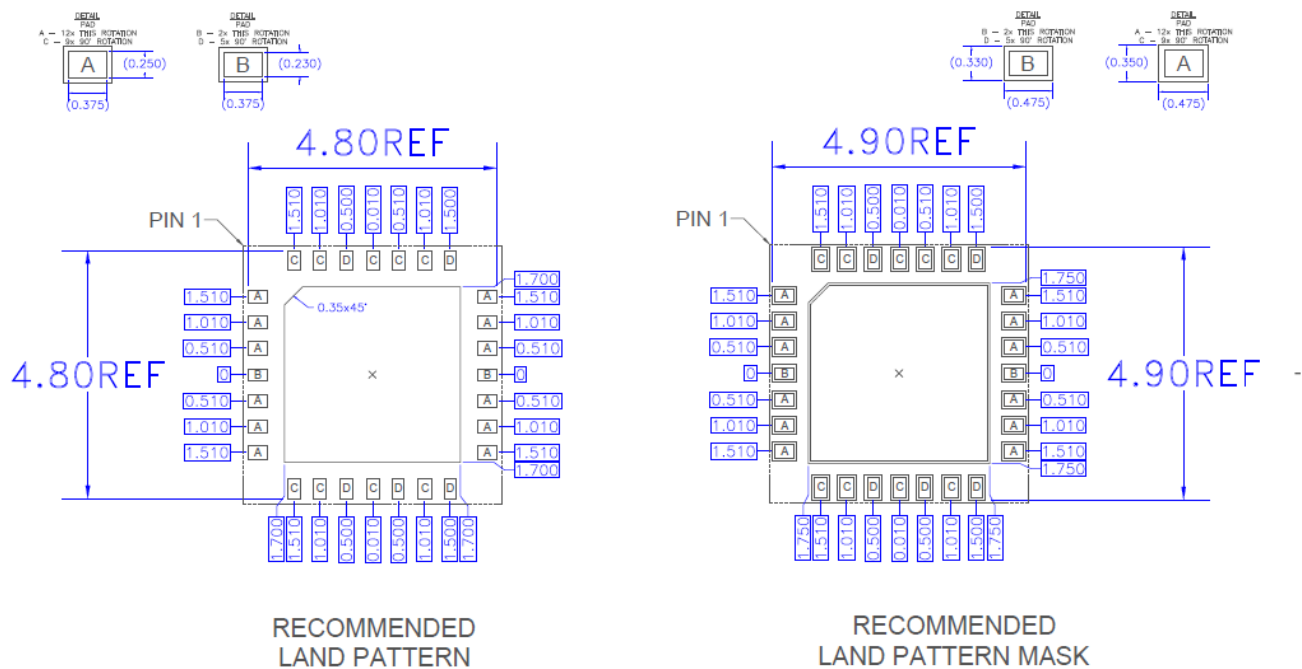
Notes:

If operating near P_{SAT} , 20 dB (>3W) attenuation pad is recommended at the output of the device to protect test equipment.

Bill of Materials

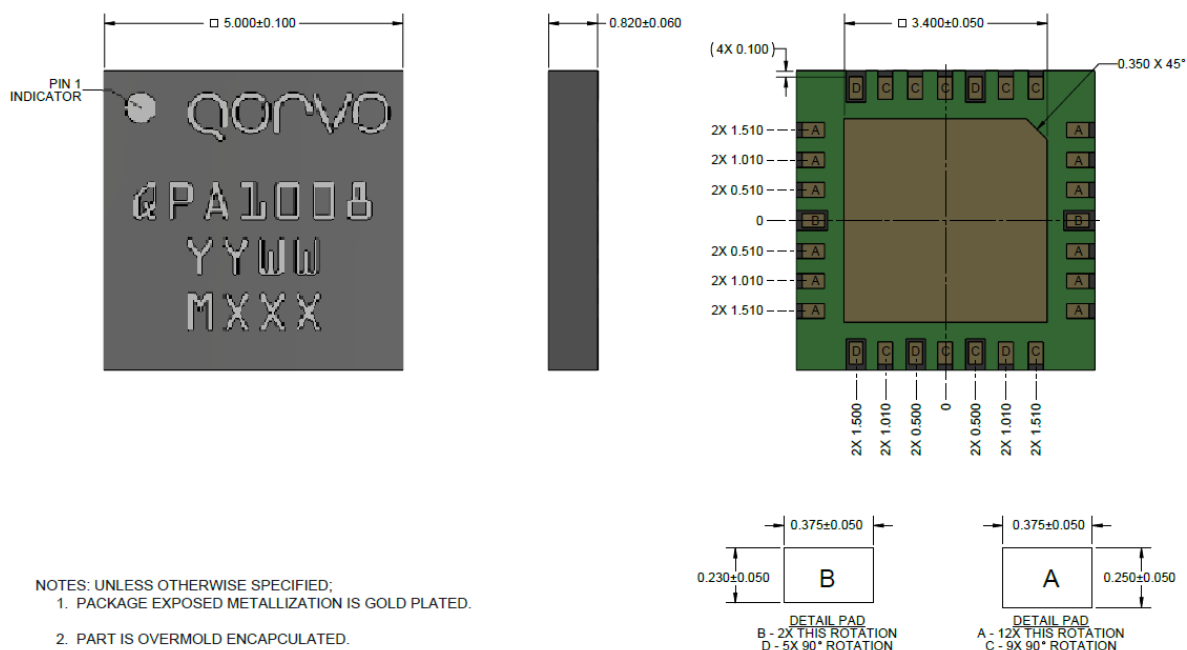
Ref. Des.	Value	Description	Manufacturer	Part Number
U1		QPA1008	Various	
C2, C3, L1, R1	0 Ω	RES, 0603, 1/16 W, Chip	Various	
C4, C6, C9	100 pF	CAP, 0603, 5%, 50 V	Various	
C5, C7, C8	1000 pF	CAP, 0603, 5%, 50 V	Various	
C10, C11, C12, C15, C16	N/A	Not used on this EVB		
C13	0.1 μ F	CAP, 0603, 10%, 50 V, X7R	Various	
C14	10 μ F	CAP, 6032, 20%, 50 V, Tantalum	Various	
L2	10 nH	IND, 0603 5%, 4800 MHz	Various	

PCB Mounting Pattern



Recommended PCB land-pad pattern metallization (Top View)

Mechanical Information



Units: millimeters

Tolerances: unless specified

x.xx = ± 0.25

x.xxx = ± 0.100

Materials:

Base: Laminate

All metalized features are gold plated

Marking:

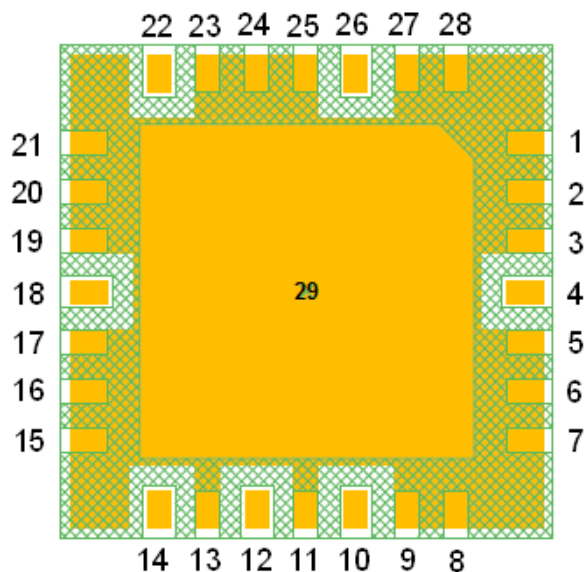
QPA1008: Part number

YY: Part Assembly year

WW: Part Assembly week

MXXX: Batch ID

Pad Description



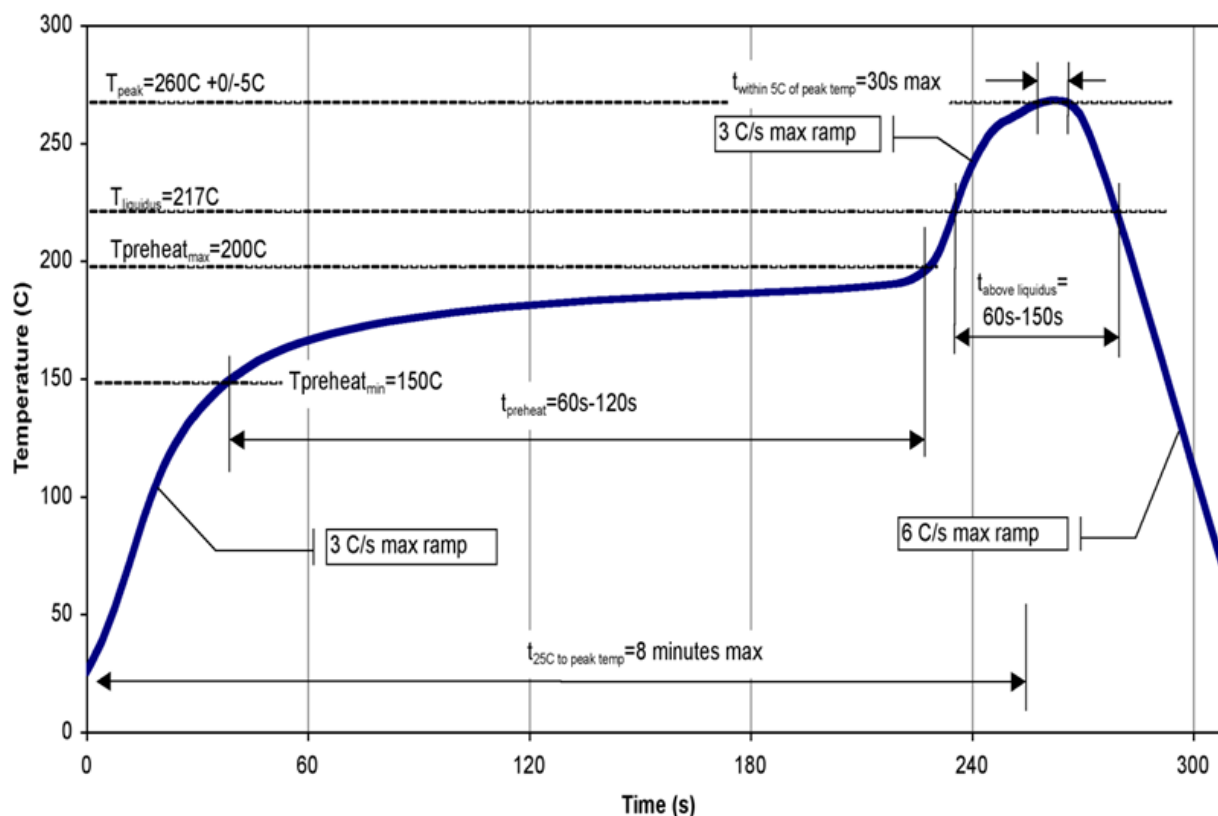
Bottom view of package base

Pin Number	Label	Description
1-3, 5-9, 11, 13, 15-17, 19-21, 23-25, 27-28	No Connect	No internal connection. Pads on PCB should be grounded to improve isolation
4	RF Input	RF input, matched to 50 Ω , DC blocked
10	V _{SW}	Attenuator Switch Control
12	V _{PD}	Bias Switch Control
14	Power Sample	Power Detector, coupled output power (resistive coupler; approximately 20 dB below output power)
18	RF Output	RF output, matched to 50 Ω , DC blocked
22	V _{CC2}	Second stage supply voltage. Bias network required
26	V _{CC1}	First stage supply voltage. Bias network required
29	GND	Ground paddle: must be grounded using plated through/copper filled via holes on PCB to improve isolation and for heat sinking

Solderability

1. Compatible with the latest version of J-STD-020, Lead-free solder, 260° C.
2. Contact plating: Ni-Pd-Au

Recommended Soldering Temperature Profile



Handling Precautions

Parameter	Rating	Standard
ESD – Human Body Model (HBM)	Class 1C	ANSI/ESD/JEDEC JS-001
ESD – Charge Device Model (CDM)	Class C3	ANSI/ESD/JEDEC JS-002
MSL – Moisture Sensitivity Level	3	IPC/JEDEC J-STD-020



Caution!
ESD-Sensitive Device

RoHS Compliance

This product is compliant with the 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment), as amended by Directive 2015/863/EU. This product also has the following attributes:

- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

Tel: 1-844-890-8163

Web: www.qorvo.com

Email: customer.support@qorvo.com

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